



- NOTE.
- ① Mounting side is mated with the receptacle:IT3M-200S-BGA(**) and fixed with the latch.
 - ② Lot No. shall be marked on the indicated position.
 - ③ The indicated mother board and daughter card shall be fastened to the additional reinforcements to prevent the stress on IT3*-200S-BGA(**) solder joints.
 - 4. More information of this product is available in HIROSE document :ETAD-F0347 "IT3 design guideline".
 - 5. This product consists of 200 signal lines and 180 ground lines.
 - 6. 40pcs of this products are packed in a soft tray.

3	LCP	BLACK	UL94V-0						
2	LCP	GRAY	UL94V-0	5	Copper Alloy	CONTACT AREA:NICKEL(1.5μm)+GOLD (0.75μm)			
1	PBT	BLACK	UL94V-0	4	Copper Alloy	CONTACT AREA:NICKEL(1.5μm)+GOLD (0.75μm)			
NO.	MATERIAL	FINISH, REMARKS		NO.	MATERIAL	FINISH, REMARKS			
UNITS mm		SCALE 2 : 1		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE	
 HIROSE ELECTRIC CO., LTD.				APPROVED : T. MATSUO	06/20/2008	DRAWING NO. EDC-157071-01			
				CHECKED : T. MATSUO	06/20/2008	PART NO. IT3-200P-32H(03)			
				DESIGNED : M. NAGATA	06/20/2008	CODE NO. CL636-0115-1-03			
				DRAWN : M. NAGATA	06/20/2008	 1/1			